

ABSTRACT

Provided is a technique capable of selectively forming a film on a substrate. The present invention has: a step for supplying an organic ligand-containing adsorption control agent to a substrate having, on the surface thereof, a first region and a second region different from the first region while adjusting the temperature of the substrate according to the composition of the first region, and for organically terminating the first region; and a step for supplying a deposition gas to the substrate and selectively growing a film in the second region.

FIGURE 4